Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)

Contact Info:

ti.com/support
Distribute - RoHS and IEC 62474 DB Form/Declaration Type:

06/03/2022 Created on:

Details for "LP5900TL-4.5/NOPB"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
LP5900TL-4.5/NOPB	SNAGCU	Level-1-260C-UNLIM	Texas Instruments Electronics	YZR 4	1.117x1.092x.304	1.4

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS		REACH	Green	IEC 62474 DB	
	Yes	Yes	Yes	Yes	

Component Information

				Homogeneous Material Level		Component Level			
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm		
Back Side Coating									
Other Inorganic Materials	Fused Silica	60676-86-0	0.068639	78.100039	781000	5.00853	50085		
Other Plastics and Rubber	Carbon Black	1333-86-4	0.000703	0.7999	7999	0.051297	513		
Other Plastics and Rubber	Other Filler		0.001582	1.800059	18001	0.115437	1154		
Thermoplastics	Epoxy	85954-11-6	0.016962	19.300002	193000	1.237703	12377		
Sub-Total			0.087886	100	1000000	6.412967	64130		
Semiconductor Device									
Ceramics / Glass	Doped Silicon	7440-21-3	0.866509	100	1000000	63.228433	632284		
Sub-Total			0.866509	100	1000000	63.228433	632284		
Solder Bump									
Copper and Its Alloys	Copper	7440-50-8	0.00208	0.499944	4999	0.151776	1518		
Nickel and Its Alloys	Nickel	7440-02-0	0.000208	0.049994	500	0.015178	152		
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.408766	98.249957	982500	29.827311	298273		
Precious Metals	Silver	7440-22-4	0.004993	1.200105	12001	0.364335	3643		
Sub-Total			0.416047	100	1000000	30.3586	303586		
Total			1.370442			100	1000000		

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the **component**. See Glossary of Terms for more details.

Important Part Information
There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

For an explanation of the methods used to determine material weights. See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is." For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/03/2022

ROHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

ROHS Exempt: Means TI semiconductor products that contain lead (Pb) above the ROHS Annex II threshold, but that fall within one of the specific ROHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (5b203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement: and Bervllium Oxide (BeO) is <=1000ppm.